March 6, 2019 — One of the world’s largest technology manufacturers has named a Utah State University College of Engineering alumnus to its corporate fellowship.

Mikal Hunsaker (BS ’89, MS ’90) was recently added to the prestigious group of 129 fellows at Intel, an important career advancement reserved for the company’s most accomplished engineers, scientists and leaders.

Hunsaker has led a 25-year career at Intel and has been involved with chipset silicon design since joining the company in 1995. Chipsets are a companion component to Intel’s CPU and provide input/output (I/O) for the platform. Today, as a product architect for Intel’s Client Computing Group and chief architect for chipsets, he is responsible for product definition of client chipsets and I/O for client CPUs.

In addition to his success as a chip architect, Hunsaker has spent several years in intellectual property development with a focus on high speed I/O for PCI Express, USB3 and SATA. He pioneered on-package, die-to-die interconnect and on-silicon PCI Express-based fabric technologies for which he is both author and inventor. And he has been awarded more than 50 U.S. patents.

Hunsaker is originally from Tremonton, Utah. He currently lives El Dorado Hills, California, with his wife, Jennifer. He has four children, three of which are USU alumni, and two grandchildren.

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